

AME8855

■ General Description

The AME8855 family of positive, CMOS linear regulators provide low dropout voltage(420mV@600mA), low quiescent current, and low noise CMOS LDO. These rugged devices have both Thermal Shutdown, and Current limit to prevent device failure under the "Worst" of operating conditions.

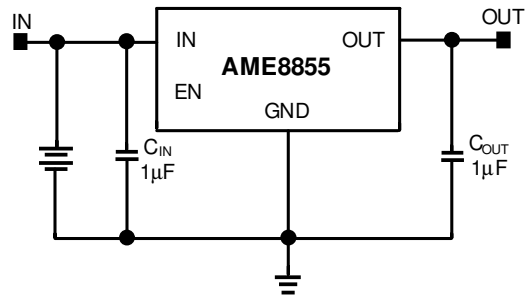
■ Features

- Low Dropout Voltage: 420mV@600mA
- Guaranteed Current: 600mA
- Quiescent Current: 60μA (typ.)
- Over-Temperature Shutdown
- Current Limiting protection
- PSRR:60dB@10KHz
- Ultra-Low-Noise: 100μV_{RMS} at 1Hz to 100KHz
- Low Temperature Coefficient
- Input Voltage Range 2.8V~5.5V
- Output Voltage Range: 0.8V ~ 4.3V
- Green Products Meet RoHS Standards

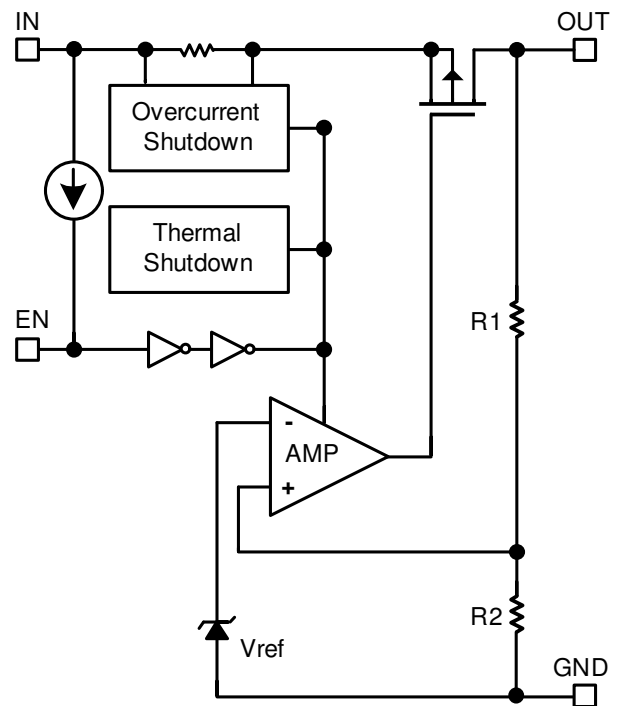
■ Applications

- Instrumentation
- Portable Electronics
- Wireless Devices
- Cordless Phones
- PC Peripherals
- Battery Powered Widgets

■ Typical Application



■ Functional Block Diagram



AME8855

■ Pin Configuration

3 Pin



AME8855-AGTxxx

1. IN
2. GND (TAB)
3. OUT

*** Die Attach:
Conductive Epoxy**



AME8855-BGTxxx

1. GND
2. OUT (TAB)
3. IN

*** Die Attach:
Non-Conductive Epoxy**



AME8855-AFTxxx

1. IN
2. GND (TAB)
3. OUT

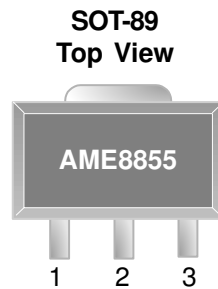
*** Die Attach:
Conductive Epoxy**



AME8855-BFTxxx

1. GND
2. OUT (TAB)
3. IN

*** Die Attach:
Non-Conductive Epoxy**



AME8855-CFTxxx

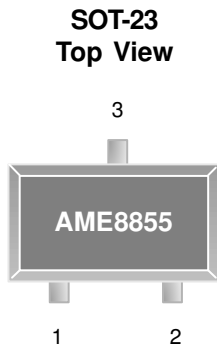
1. GND
2. IN (TAB)
3. OUT

*** Die Attach:
Non-Conductive Epoxy**

AME8855

■ Pin Configuration (Contd.)

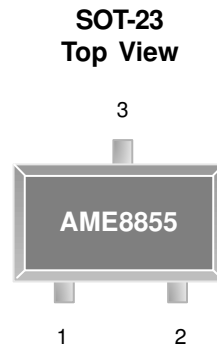
3 Pin



AME8855-AETxxx

1. IN
2. GND
3. OUT

*** Die Attach:
Non-Conductive Epoxy**

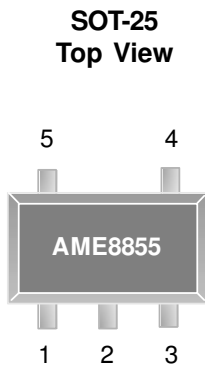


AME8855-BETxxx

1. GND
2. OUT
3. IN

*** Die Attach:
Non-Conductive Epoxy**

5 Pin

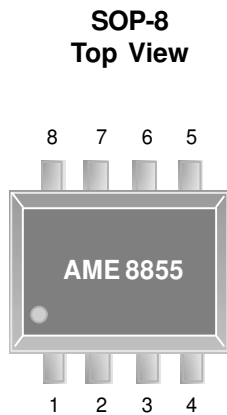


AME8855-AEVxxx

1. IN
2. GND
3. EN
4. NC
5. OUT

*** Die Attach:
Conductive Epoxy**

8 Pin



AME8855-AHAxxx

1. IN
2. GND
3. GND
4. OUT
5. NC
6. GND
7. GND
8. EN

*** Die Attach:
Conductive Epoxy**

AME8855
■ Pin Description
SOT-223

| Pin Number | | Pin Name | Pin Description |
|------------|---|----------|--|
| A | B | | |
| 1 | 3 | IN | Input voltage pin; should be decoupled with 1 μ F or greater capacitor. |
| 2 | 1 | GND | Ground connection pin. |
| 3 | 2 | OUT | LDO voltage regulator output pin; should be decoupled with a 1.0 μ F or greater value low ESR ceramic capacitor. |

SOT-89

| Pin Number | | | Pin Name | Pin Description |
|------------|---|---|----------|--|
| A | B | C | | |
| 1 | 3 | 2 | IN | Input voltage pin; should be decoupled with 1 μ F or greater capacitor. |
| 2 | 1 | 1 | GND | Ground connection pin. |
| 3 | 2 | 3 | OUT | LDO voltage regulator output pin; should be decoupled with a 1.0 μ F or greater value low ESR ceramic capacitor. |

SOT-23

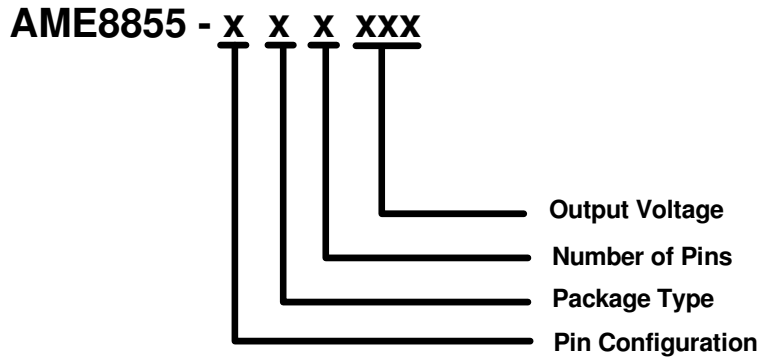
| Pin Number | | Pin Name | Pin Description |
|------------|---|----------|--|
| A | B | | |
| 1 | 3 | IN | Input voltage pin; should be decoupled with 1 μ F or greater capacitor. |
| 2 | 1 | GND | Ground connection pin. |
| 3 | 2 | OUT | LDO voltage regulator output pin; should be decoupled with a 1.0 μ F or greater value low ESR ceramic capacitor. |

AME8855
■ Pin Configuration
SOP-25

| Pin Number | Pin Name | Pin Description |
|------------|----------|--|
| 1 | IN | Input voltage pin; should be decoupled with 1 μ F or greater capacitor. |
| 2 | GND | Ground connection pin. |
| 3 | EN | Enable pin, Active "high". When pulled "low", the PMOS pass transistor turns off, current consuming less than 1 μ A. When EN pin floating outside, it's weakly pulled high from internal MOS . |
| 4 | NC | No connection. |
| 5 | OUT | LDO voltage regulator output pin; should be decoupled with a 1.0 μ F or greater value low ESR ceramic capacitor. |

SOP-8

| Pin Number | Pin Name | Pin Description |
|------------|----------|--|
| 1 | IN | Input voltage pin; should be decoupled with 1 μ F or greater capacitor. |
| 2 | GND | Ground connection pin. |
| 3 | GND | Ground connection pin. |
| 4 | OUT | LDO voltage regulator output pin; should be decoupled with a 1.0 μ F or greater value low ESR ceramic capacitor. |
| 5 | NC | No connection. |
| 6 | GND | Ground connection pin. |
| 7 | GND | Ground connection pin. |
| 8 | EN | Enable pin, Active "high". When pulled "low", the PMOS pass transistor turns off, current consuming less than 1 μ A. When EN pin floating outside, it's weakly pulled high from internal MOS . |

AME8855
■ Ordering Information


| Pin Configuration | Package Type | Number of Pins | Output Voltage |
|--|--|----------------------|--|
| A 1. IN <small>(SOT-223)</small> 2. GND <small>(SOT-23)</small> 3. OUT <small>(SOT-89)</small> | E: SOT-2X F: SOT-89 G: SOT-223 H: SOP | A: 8 T: 3 V: 5 | 080: 0.8V 090: 0.9V 100: 1.0V 110: 1.1V 120: 1.2V 130: 1.3V 140: 1.4V 150: 1.5V : : : : 420: 4.2V 430: 4.3V |
| B 1. GND <small>(SOT-223)</small> 2. OUT <small>(SOT-23)</small> 3. IN <small>(SOT-89)</small> | | | |
| C 1. GND <small>(SOT-89)</small> 2. IN 3. OUT | | | |
| A 1. IN <small>(SOT-25)</small> 2. GND 3. EN 4. BYP 5. OUT | | | |
| A 1. IN <small>(SOP-8)</small> 2. GND 3. GND 4. OUT 5. NC 6. GND 7. GND 8. EN | | | |

AME8855
■ Absolute Maximum Ratings

| Parameter | | Maximum | Unit |
|--------------------|-----|----------------------------|------|
| Input Voltage | | -0.3 to 6 | V |
| EN Voltage | | -0.3 to 6 | V |
| Output Current | | $P_D / (V_{IN} - V_{OUT})$ | mA |
| Output Voltage | | GND-0.3 to $V_{IN} + 0.3$ | V |
| ESD Classification | HBM | 2 | kV |
| | MM | 200 | V |

Caution: Stress above the listed in absolute maximum ratings may cause permanent damage to the device.

■ Recommended Operating Conditions

| Parameter | Symbol | Rating | Unit |
|----------------------------|-----------|--------------|------|
| Ambient Temperature Range | T_A | - 40 to +85 | °C |
| Junction Temperature Range | T_J | - 40 to +125 | °C |
| Storage Temperature Range | T_{STG} | - 65 to +150 | °C |

■ Thermal Information

| Parameter | Package | Die Attach | Symbol | Maximum | Unit |
|---|---------|----------------------|---------------|---------|--------|
| Thermal Resistance* (Junction to Case) | SOT-89 | Conductive Epoxy | θ_{JC} | 40 | °C / W |
| | | Non-Conductive Epoxy | | 46 | |
| | SOT-223 | Conductive Epoxy | | 25 | |
| | | Non-Conductive Epoxy | | 31 | |
| | SOT-23 | Non-Conductive Epoxy | | 140 | |
| | SOT-25 | Conductive Epoxy | | 81 | |
| | SOP-8 | Conductive Epoxy | | 60 | |
| Thermal Resistance (Junction to Ambient) | SOT-89 | Conductive Epoxy | θ_{JA} | 180 | °C / W |
| | | Non-Conductive Epoxy | | 180 | |
| | SOT-223 | Conductive Epoxy | | 120 | |
| | | Non-Conductive Epoxy | | 135 | |
| | SOT-23 | Non-Conductive Epoxy | | 280 | |
| | SOT-25 | Conductive Epoxy | | 260 | |
| | SOP-8 | Conductive Epoxy | | 150 | |
| Internal Power Dissipation | SOT-89 | Conductive Epoxy | P_D | 550 | mW |
| | | Non-Conductive Epoxy | | 550 | |
| | SOT-223 | Conductive Epoxy | | 900 | |
| | | Non-Conductive Epoxy | | 800 | |
| | SOT-23 | Non-Conductive Epoxy | | 400 | |
| | SOT-25 | Conductive Epoxy | | 400 | |
| | SOP-8 | Conductive Epoxy | | 810 | |
| Maximum Junction Temperature | | | | 150 | °C |
| Lead Temperature (Soldering, 10Sec.)** | | | | 260 | °C |

* Measure θ_{JC} on backside center of molding compound if IC has no tab.

** MIL-STD-202G210F

AME8855
■ Electrical Specifications

$V_{IN} = V_{OUT(NOM)} + 1V$, (for $V_{OUT} < 2V$, $V_{IN} = 2.8V$), $I_{OUT} = 1mA$, and $C_{OUT} = 1\mu F$, $C_{IN} = 1\mu F$ unless otherwise noted.
Typical values are at $T_A = 25^\circ C$.

| Parameter | Symbol | Test Condition | Min | Typ | Max | Units |
|---|---------------|---|------|-------|-------|---------|
| Input Voltage | V_{IN} | | 2.8 | | 5.5 | V |
| Output Accuracy | $V_{OUT,ACC}$ | $I_{OUT} = 1mA$ | -2.0 | | 2.0 | % |
| Output Voltage Range | V_{OUT} | | 0.8 | | 4.3 | V |
| Dropout Voltage (Note 1) | V_{DROP} | $I_{OUT} = 600mA$, $0.8V \leq V_{OUT(NOM)} \leq 2.0V$ | | | Note2 | mV |
| | | $I_{OUT} = 600mA$, $2.0V < V_{OUT(NOM)} \leq 2.8V$ | | | 850 | |
| | | $I_{OUT} = 600mA$, $2.8V < V_{OUT(NOM)}$ | | 420 | 650 | |
| Output Current | I_{OUT} | | 600 | | | mA |
| Quiescent Current | I_Q | $I_{OUT} = 0mA$ | | 60 | 90 | μA |
| Line Regulation $\frac{\Delta V_{OUT}}{\Delta V_{IN}} \times 100\%$ $\frac{\Delta V_{OUT}}{V_{OUT}}$ | REG_{LINE} | $I_{OUT} = 1mA$, $0.8V \leq V_{OUT} \leq 1.2V$, $2.8V \leq V_{IN} \leq 3.5V$ | | 0.125 | 0.25 | %V |
| | | $I_{OUT} = 1mA$, $1.2V < V_{OUT} \leq 2.0V$, $2.8V \leq V_{IN} \leq 3.5V$ | | 0.1 | 0.2 | |
| | | $I_{OUT} = 1mA$, $2.0V < V_{OUT} \leq 4.2V$, $V_{IN(MIN)} \leq V_{IN} \leq V_{IN(MIN)} + 1V$ | | 0.05 | 0.1 | |
| | | $I_{OUT} = 1mA$, $4.2V < V_{OUT} \leq 4.5V$, $V_{IN(MIN)} \leq V_{IN} \leq 5.5V$ (Note2) | | 0.05 | 0.1 | |
| Load Regulation $\frac{\Delta V_{OUT}}{V_{OUT}} \times 100\%$ $\frac{\Delta V_{OUT}}{\Delta I_{OUT}}$ | REG_{LOAD} | $1mA \leq I_{OUT} \leq 600mA$ $0.8V \leq V_{OUT(NOM)} \leq 1.2V$ | | 1.5 | 3 | %A |
| | | $1mA \leq I_{OUT} \leq 600mA$ $1.2V \leq V_{OUT(NOM)} \leq 2.0V$ | | 1.25 | 2.5 | |
| | | $1mA \leq I_{OUT} \leq 600mA$ $2.0V < V_{OUT(NOM)}$ | | 1.0 | 2.0 | |

AME8855
■ Electrical Specifications (Contd.)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Units | |
|-------------------------------|-----------------|---|---------|-----|----------|---------------|----|
| Power Supply Rejection Ration | PSRR | $C_{OUT}=1\mu F, V_{OUT}=0.8V$ $I_{OUT}=10mA$ $V_{IN}=2.8V$ | F=100Hz | | 60 | | dB |
| | | | F=1KHz | | 60 | | |
| | | | F=10KHz | | 60 | | |
| Output Voltage Noise | eN | $I_{OUT}=10mA, V_{OUT}=0.8V,$ f=1Hz to 100KHz | | 100 | | μV_{RMS} | |
| Enable High (Enabled) | $V_{EN,HI}$ | $V_{IN(MIN)} \leq V_{IN} \leq 5.5V$ | 1.4 | | V_{IN} | V | |
| Enable Low (Shutdown) | $V_{EN,LO}$ | $V_{IN(MIN)} \leq V_{IN} \leq 5.5V$ | 0 | | 0.4 | | |
| Enable Input Bias Current | $I_{EN,HI}$ | $V_{EN}=V_{IN}$ | | | 1 | μA | |
| | $I_{EN,LO}$ | $V_{EN}=0V$ | | | 2 | | |
| Shutdown Current | I_{SHDN} | $V_{IN}=5.0V, V_{EN}=0V$ | | 0.1 | 1 | μA | |
| Shutdown Output Voltage | $V_{OUT,SD}$ | $I_{OUT}=0.4mA, V_{EN}=0V$ | | | 0.4 | V | |
| Protection | | | | | | | |
| Output Current Limit | I_{LIM} | $V_{OUT}=0.9 \times V_{OUT(NOM)}$ | 750 | | | mA | |
| Short-Circuit Current | I_{SC} | $V_{OUT} \leq 0.6V$ | | 300 | | | |
| Thermal Shutdown Temperature | T_{SHDN} | Shutdown, temperature increasing | | 150 | | $^{\circ}C$ | |
| Thermal Shutdown Hysteresis | $T_{SHDN(HYS)}$ | | | 20 | | | |

Note1: Dropout Voltage is measured at $V_{OUT}=V_{OUT(NOM)} \times 98\%$

Note2: For V_{OUT} below 2.0V, Dropout Voltage is the Input(MIN) Voltage to Output Voltage differential.

AME8855

■ Detailed Description

The AME8855 family of CMOS regulators contain a PMOS pass transistor, voltage reference, error amplifier, over-current protection thermal shutdown, and Power Good detection circuitry.

The P-channel pass transistor receives data from the error amplifier, over-current shutdown, and thermal protection circuits. During normal operation, the error amplifier compares the output voltage to a precision reference. Over-current and Thermal shutdown circuits become active when the junction temperature exceeds 150°C, or the current exceeds 600mA. During thermal shutdown, the output voltage remains low. Normal operation is restored when the junction temperature drops more 20°C.

Capacitor Selection and Regulator Stability

The AME8855 is stable with an output capacitor to ground of 1µF or greater. Ceramic capacitors have the lowest ESR, and will offer the best AC performance. Conversely, Aluminum Electrolytic capacitors exhibit the highest ESR, resulting in the poorest AC response. Unfortunately, large value ceramic capacitors are comparatively expensive. One option is to parallel a 0.1µF ceramic capacitor with a 10µF Aluminum Electrolytic. The benefit is low ESR, high capacitance, and low overall cost.

A second capacitor is recommended between the input and ground to stabilize V_{IN} . The input capacitor should be at least 0.1µF to have a beneficial effect.

Enable Pin

The Enable Pin is Active High. When activated pulled low, the MOS pass transistor shuts off, and all internal circuits are powered down. In this state, the stand by current is than 1µA. When EN pin float outside, It's pulled high.

Capacitor Selection and Regulator Stability

The maximum output power of the AME8855 is limited by the maximum power dissipation of the package. By calculation the power dissipation of the package as a function of the input voltage, output voltage and output current, the maximum input voltage can be obtained. The maximum power dissipation should not exceed the package's maximum power rating.

$$P_{MAX} = (V_{IN(MAX)} - V_{OUT}) \times I_{OUT}$$

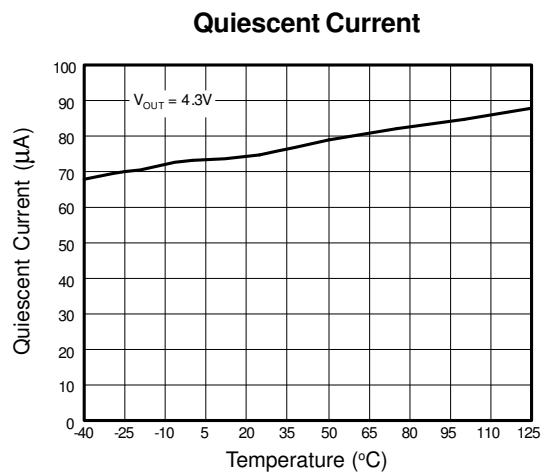
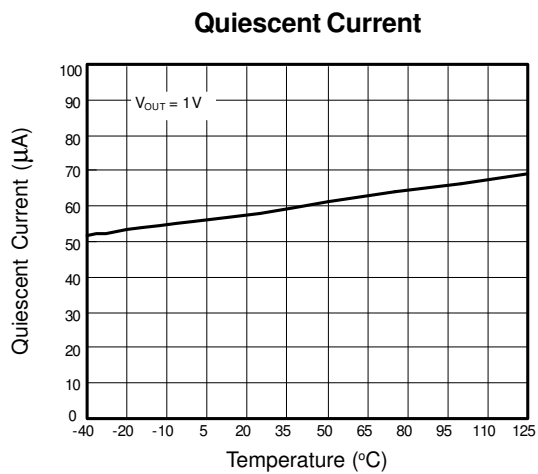
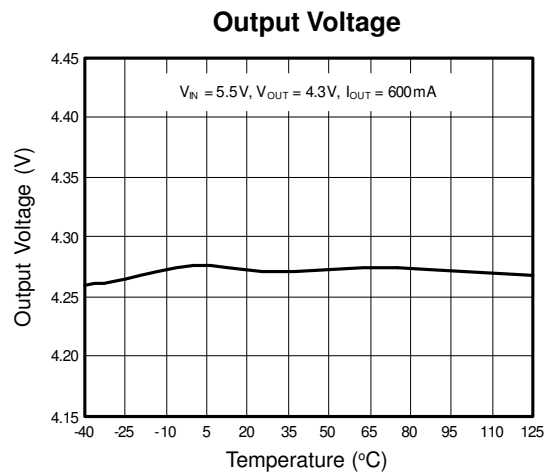
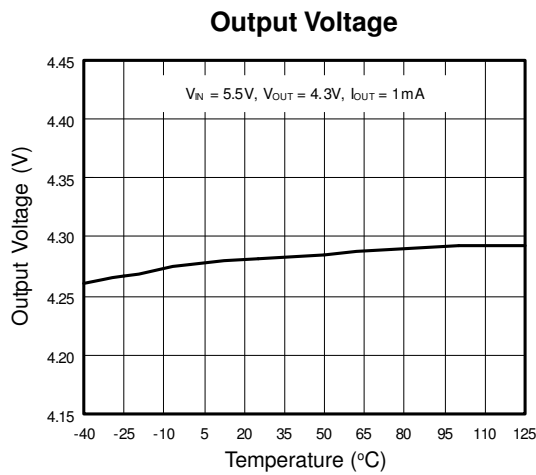
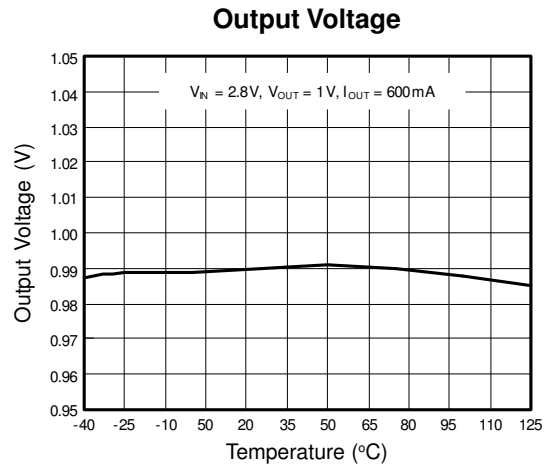
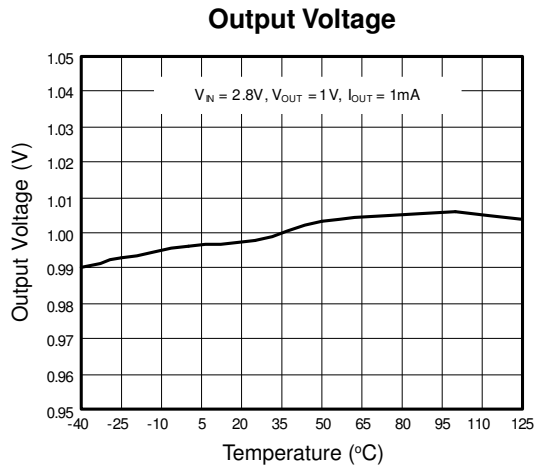
Where:

$V_{IN(MAX)}$ = maximum input voltage

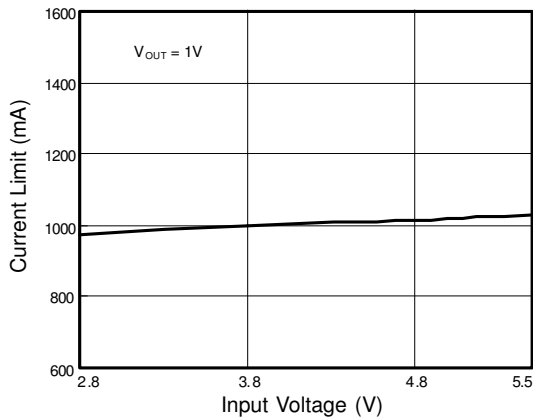
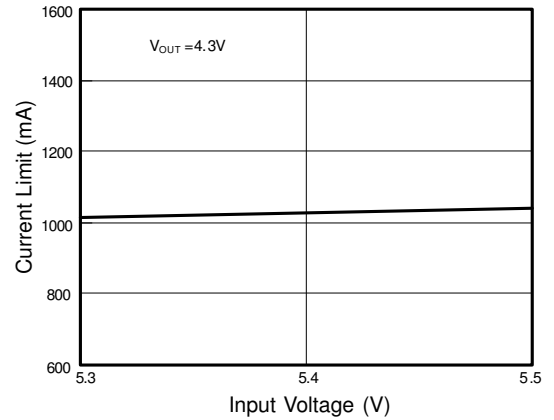
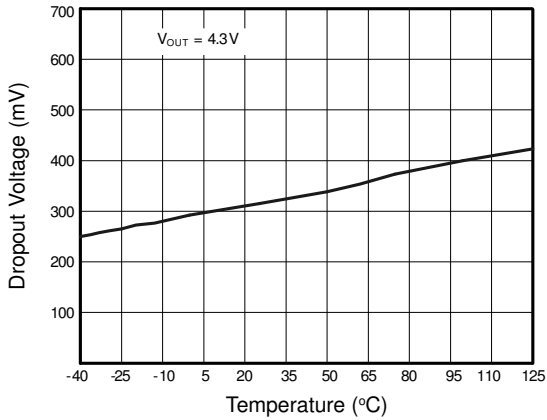
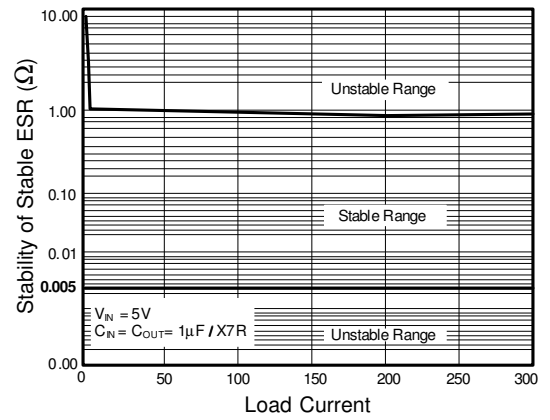
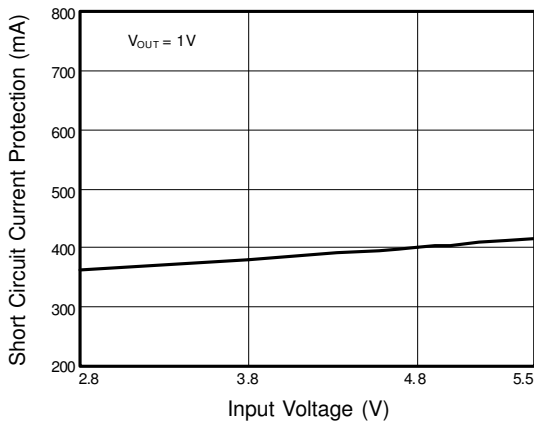
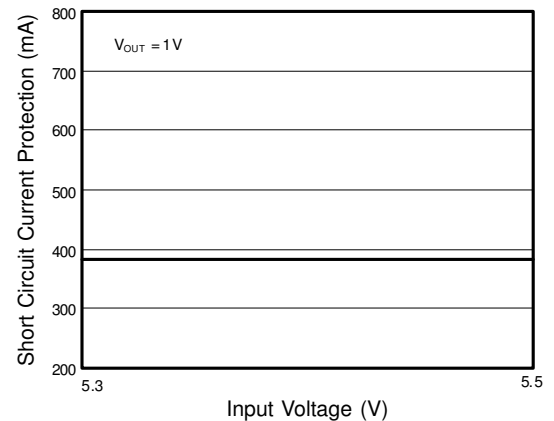
P_{MAX} = maximum power dissipation of the package

AME8855

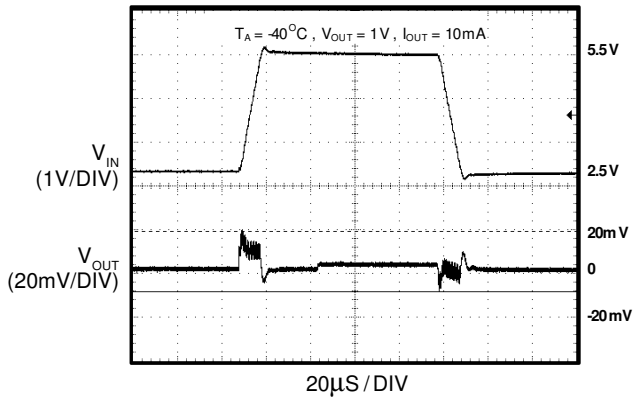
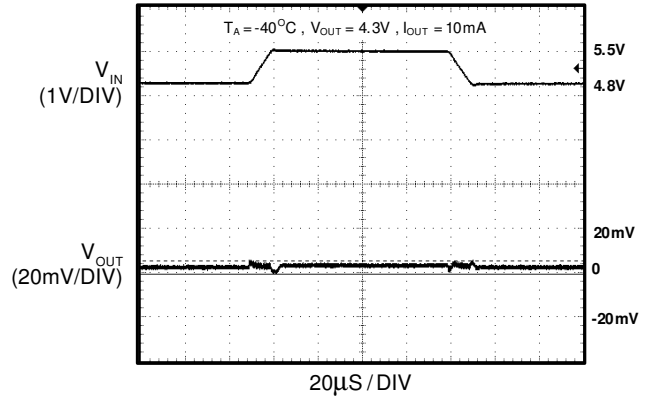
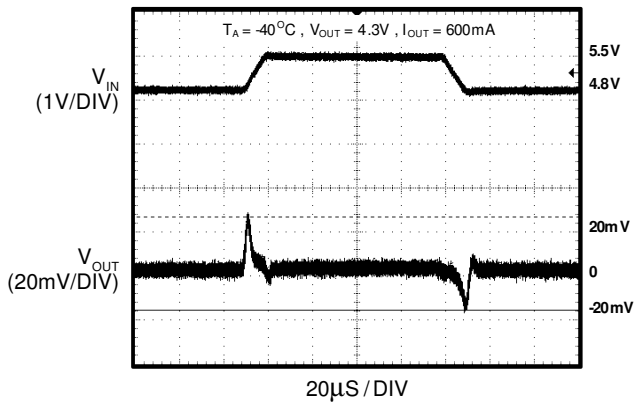
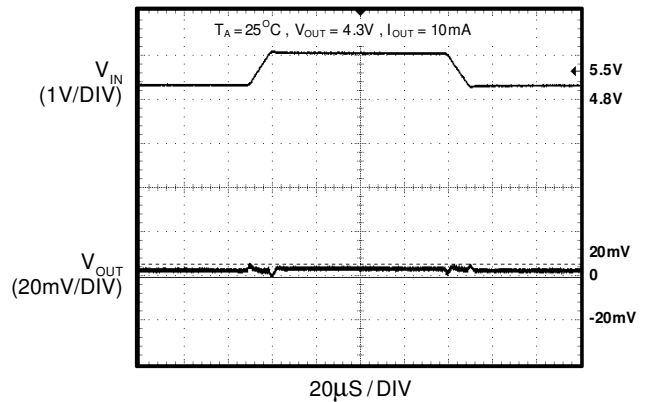
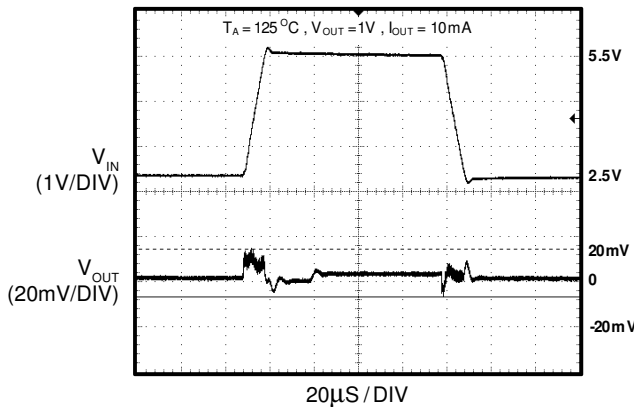
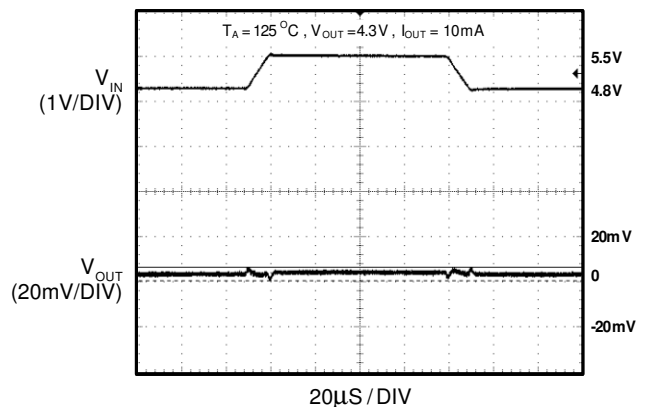
■ Characterization Curve



■ Characterization Curve (Contd.)

Current Limit vs Input Voltage

Current Limit vs Input Voltage

Dropout Voltage

Stability vs. ESR vs. Load Current

Short Circuit Current Protection

Short Circuit Current Protection


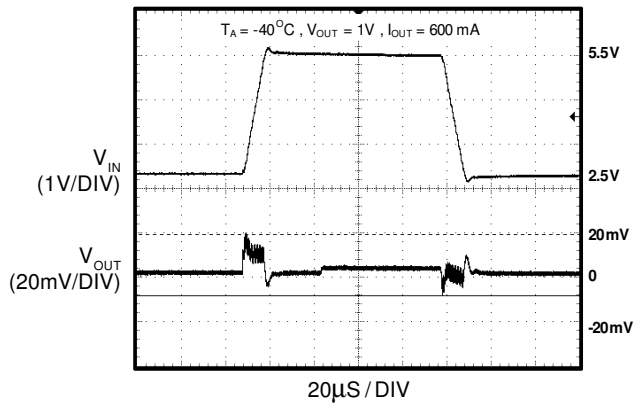
■ Characterization Curve (Contd.)

Line Transient Response

Line Transient Response

Line Transient Response

Line Transient Response

Line Transient Response

Line Transient Response


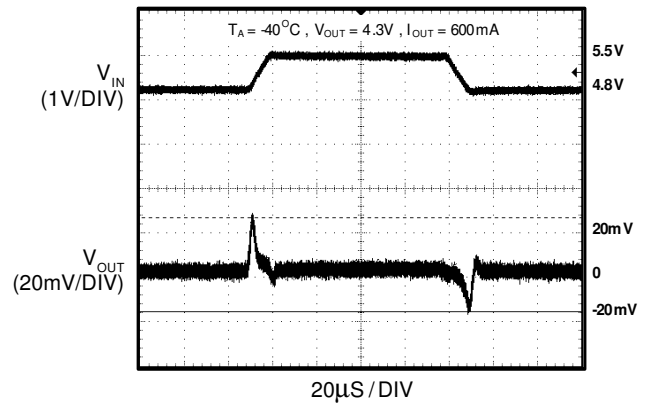
AME8855

■ Characterization Curve (Contd.)

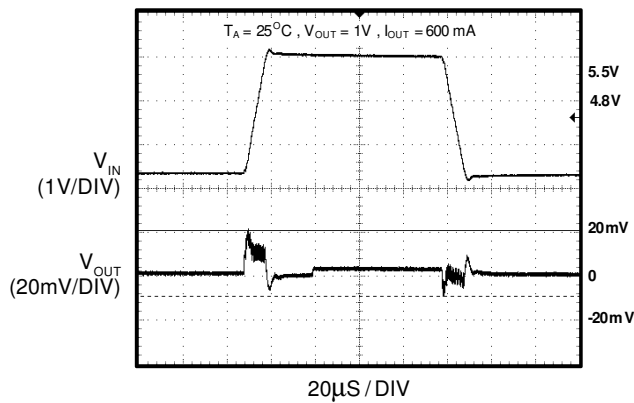
Line Transient Response



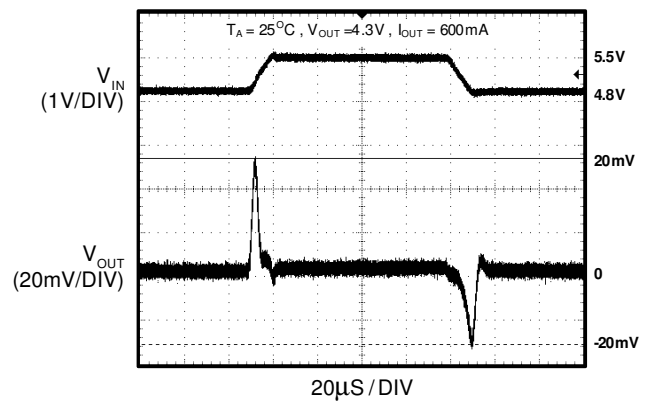
Line Transient Response



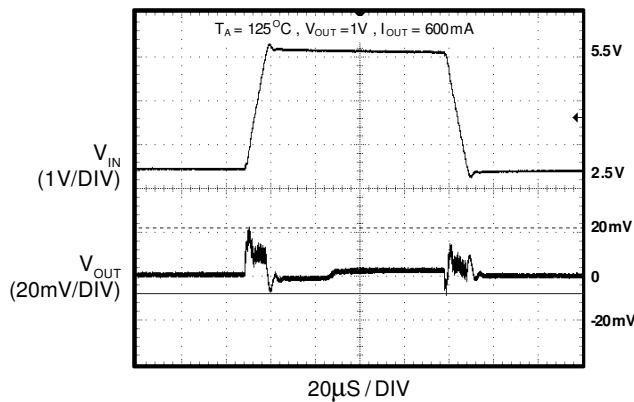
Line Transient Response



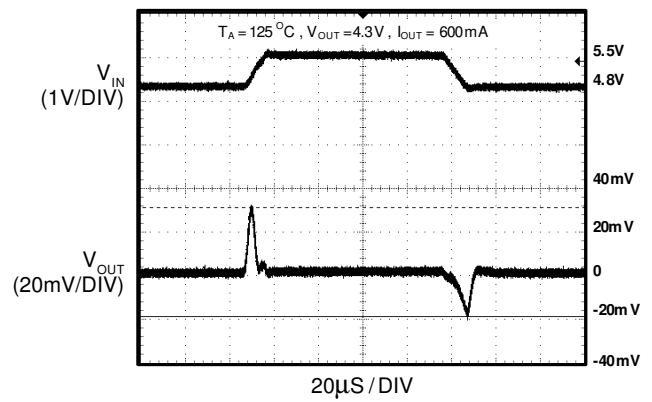
Line Transient Response



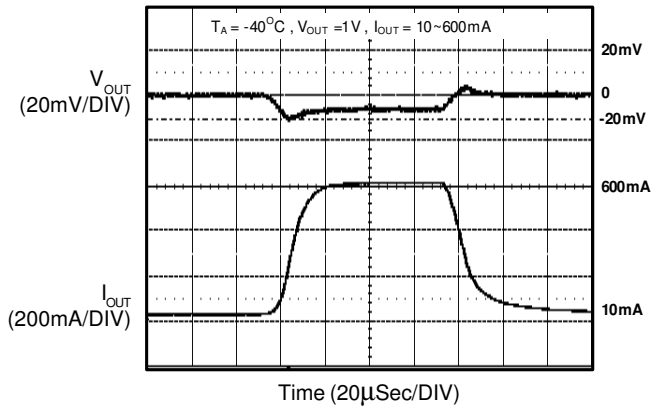
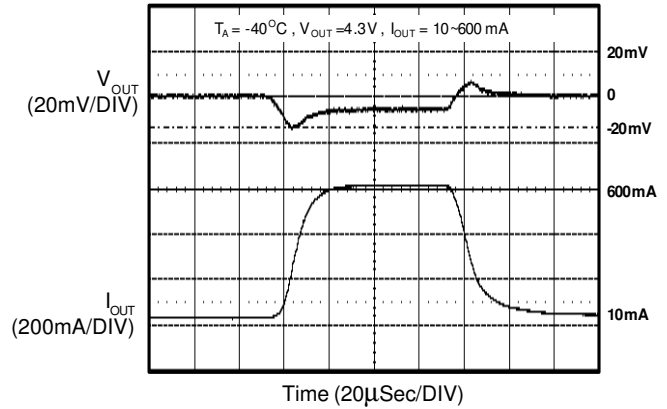
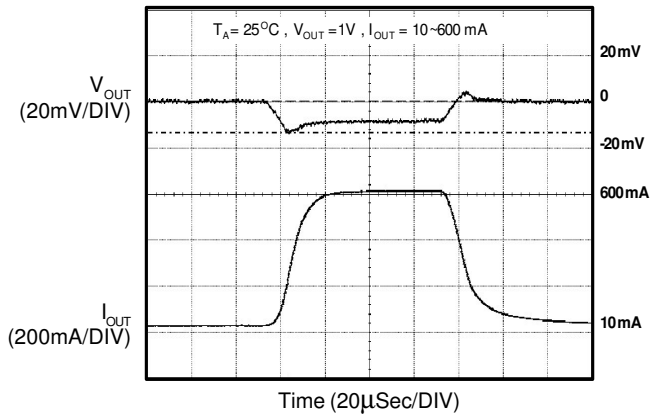
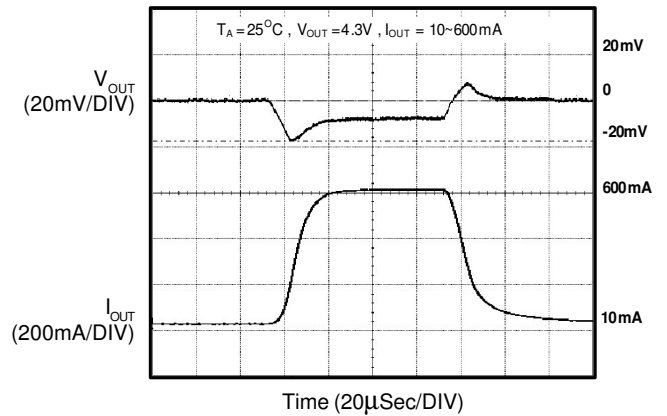
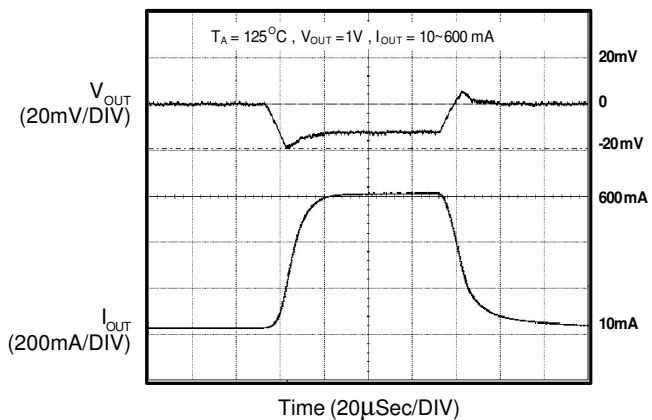
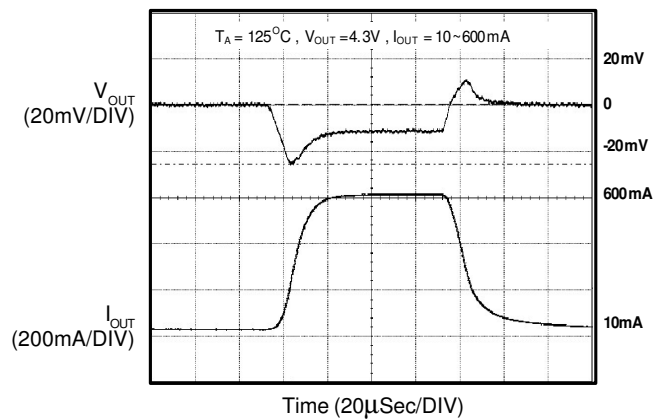
Line Transient Response



Line Transient Response



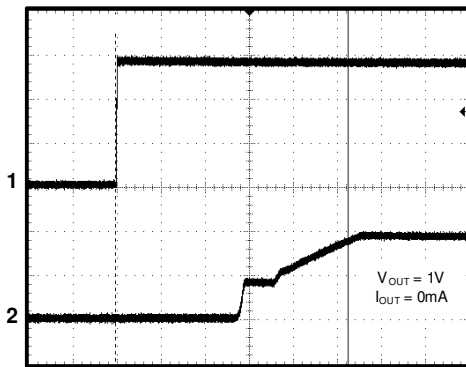
■ Characterization Curve (Contd.)

Load Transient Response

Load Transient Response

Load Transient Response

Load Transient Response

Load Transient Response

Load Transient Response


AME8855

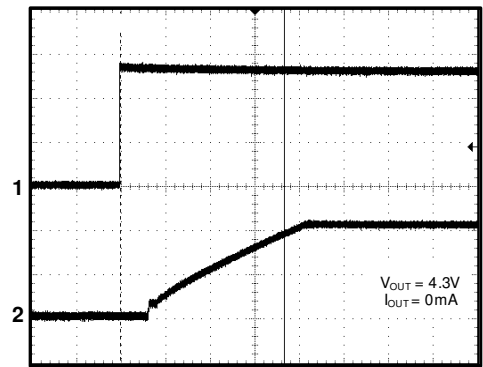
■ Characterization Curve (Contd.)

Chip Enable Transient Response



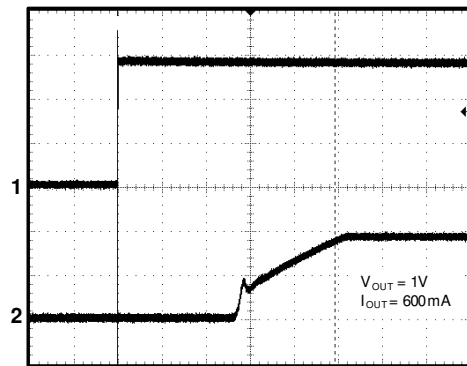
- 1) EN= 2V/Div
- 2) V_{OUT} = 500mV/Div

Chip Enable Transient Response



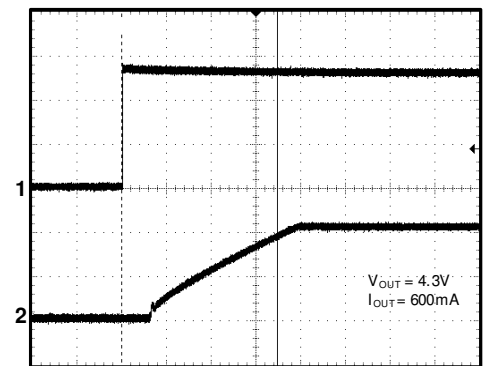
- 1) EN= 2V/Div
- 2) V_{OUT} = 2V/Div

Chip Enable Transient Response



- 1) EN= 1V/Div
- 2) V_{OUT} = 500mV/Div

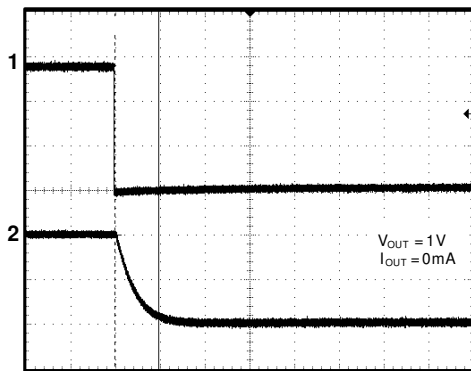
Chip Enable Transient Response



- 1) EN= 2V/Div
- 2) V_{OUT} = 2V/Div

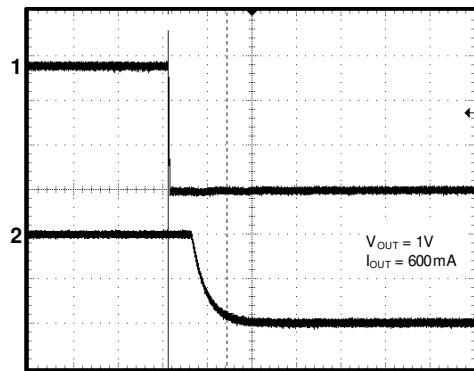
■ Characterization Curve (Contd.)

Shut Down Curve Output Voltage



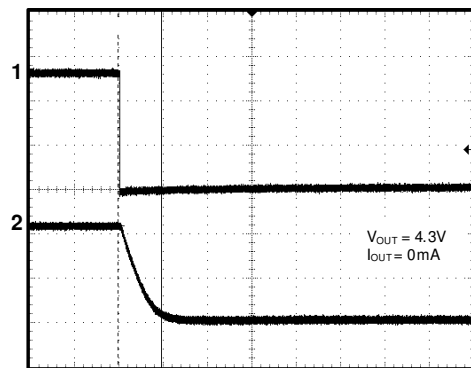
- 1) EN= 1V/Div
- 2) V_{OUT} = 500mV/Div

Shut Down Curve Output Voltage



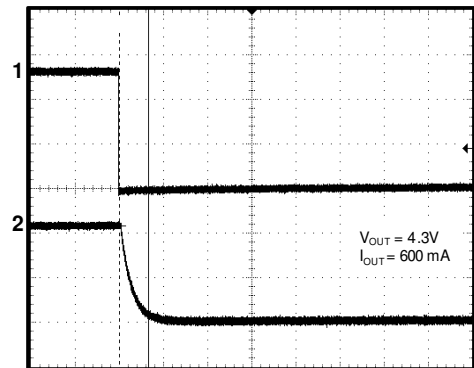
- 1) EN= 1V/Div
- 2) V_{OUT} = 500mV/Div

Shut Down Curve Output Voltage



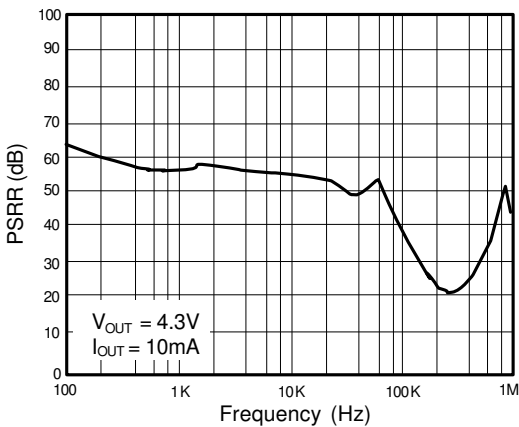
- 1) EN= 2V/Div
- 2) V_{OUT} = 2V/Div

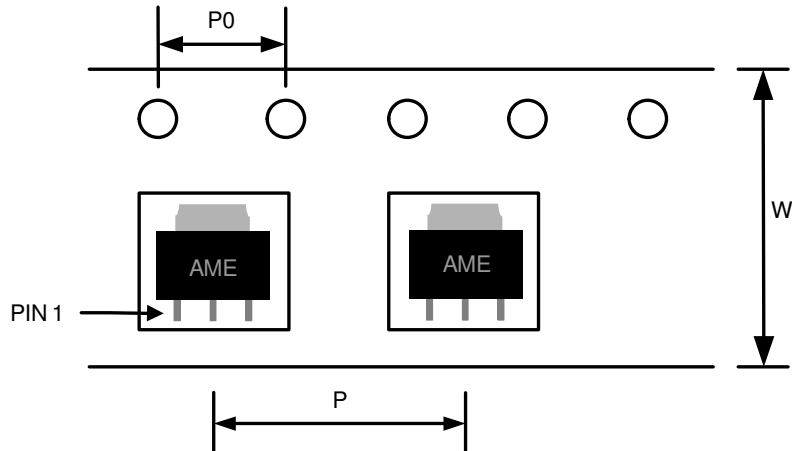
Shut Down Curve Output Voltage



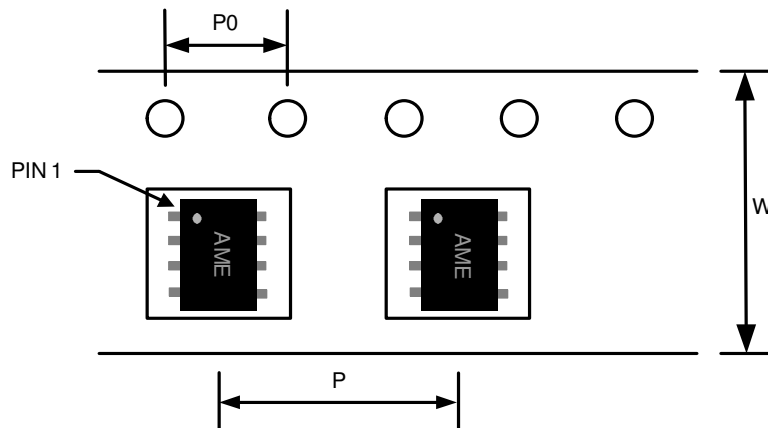
- 1) EN= 2V/Div
- 2) V_{OUT} = 2V/Div

PSRR vs Frequency

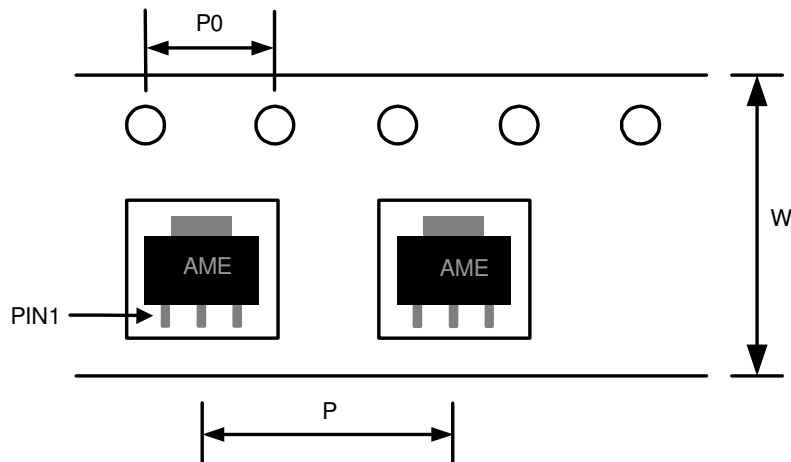


AME8855
■ Tape and Reel Dimension
SOT-223

Carrier Tape, Number of Components Per Reel and Reel Size

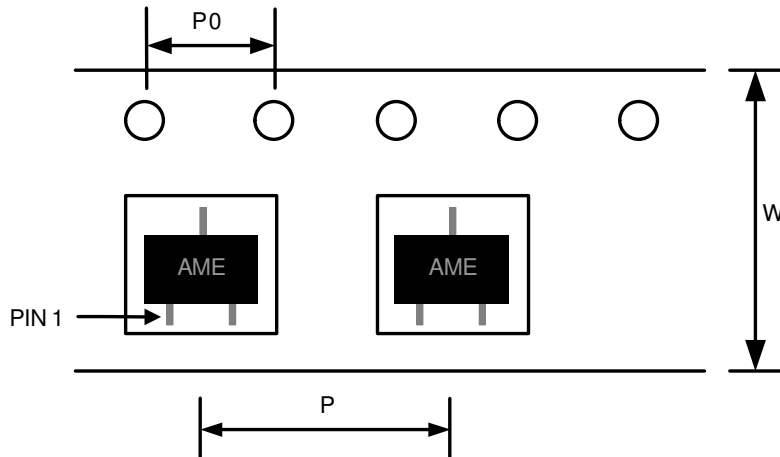
| Package | Carrier Width (W) | Pitch (P) | Pitch (P0) | Part Per Full Reel | Reel Size |
|---------|-------------------|------------|------------|--------------------|-----------|
| SOT-223 | 12.0±0.1 mm | 8.0±0.1 mm | 4.0±0.1 mm | 2500pcs | 330±1 mm |

SOP-8

Carrier Tape, Number of Components Per Reel and Reel Size

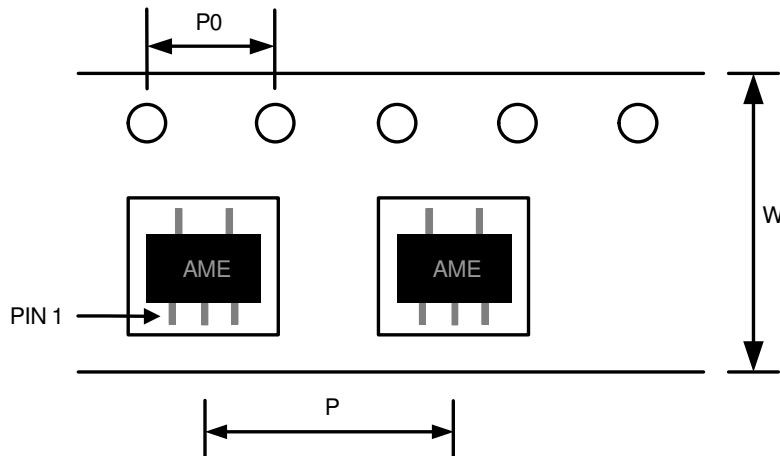
| Package | Carrier Width (W) | Pitch (P) | Pitch (P0) | Part Per Full Reel | Reel Size |
|---------|-------------------|------------|------------|--------------------|-----------|
| SOP-8 | 12.0±0.1 mm | 8.0±0.1 mm | 4.0±0.1 mm | 2500pcs | 330±1 mm |

AME8855
■ Tape and Reel Dimension (Contd.)
SOT-89

Carrier Tape, Number of Components Per Reel and Reel Size

| Package | Carrier Width (W) | Pitch (P) | Pitch (P0) | Part Per Full Reel | Reel Size |
|---------|-------------------|------------|------------|--------------------|-----------|
| SOT-89 | 12.0±0.1 mm | 8.0±0.1 mm | 4.0±0.1 mm | 1000pcs | 180±1 mm |

AME8855
■ Tape and Reel Dimension (Contd.)
SOT-23

Carrier Tape, Number of Components Per Reel and Reel Size

| Package | Carrier Width (W) | Pitch (P) | Pitch (P0) | Part Per Full Reel | Reel Size |
|---------|-------------------|------------|------------|--------------------|-----------|
| SOT-23 | 8.0±0.1 mm | 4.0±0.1 mm | 4.0±0.1 mm | 3000pcs | 180±1 mm |

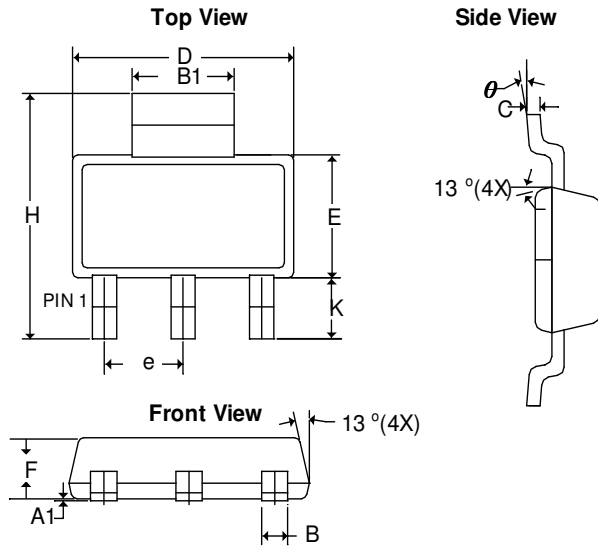
SOT-25

Carrier Tape, Number of Components Per Reel and Reel Size

| Package | Carrier Width (W) | Pitch (P) | Pitch (P0) | Part Per Full Reel | Reel Size |
|---------|-------------------|------------|------------|--------------------|-----------|
| SOT-25 | 8.0±0.1 mm | 4.0±0.1 mm | 4.0±0.1 mm | 3000pcs | 180±1 mm |

AME8855

■ Package Dimension

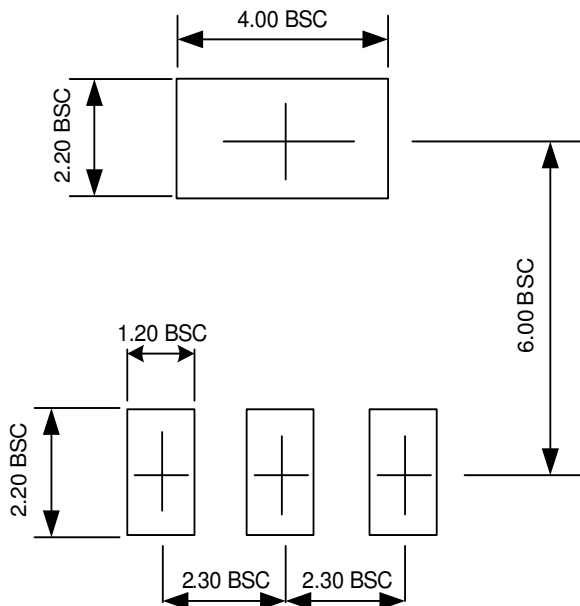
SOT-223



| SYMBOLS | MILLIMETERS | | INCHES | |
|----------------|-------------|-------|------------|--------|
| | MIN | MAX | MIN | MAX |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.0039 |
| B | 0.60 | 0.84 | 0.0236 | 0.0330 |
| B ₁ | 2.90 | 3.15 | 0.1140 | 0.1240 |
| C | 0.23 | 0.38 | 0.0091 | 0.0150 |
| D | 6.20 | 6.71 | 0.2441 | 0.2640 |
| E | 3.30 | 3.71 | 0.1299 | 0.1460 |
| e | 2.30 BSC | | 0.0906 BSC | |
| F | 1.40 | 1.80 | 0.0551 | 0.0709 |
| H | 6.70 | 7.30 | 0.2638 | 0.2874 |
| K | 1.665 | 1.669 | 0.0656 | 0.0657 |
| θ | 0° | 10° | 0° | 10° |

■ Lead Pattern

■ Lead Pattern



Note:

1. Lead pattern unit description:

BSC: Basic. Represents theoretical exact dimension or dimension target.

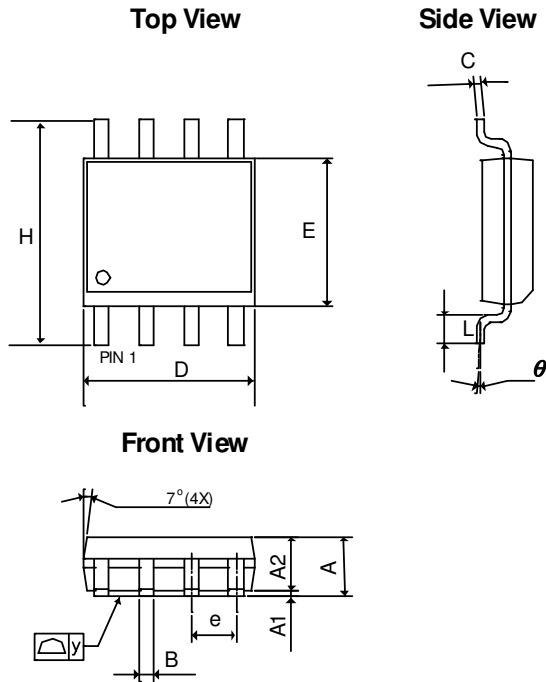
2. Dimensions in Millimeters.

3. General tolerance $\pm 0.05\text{mm}$ unless otherwise specified.

AME8855

■ Package Dimension (Contd.)

SOP-8

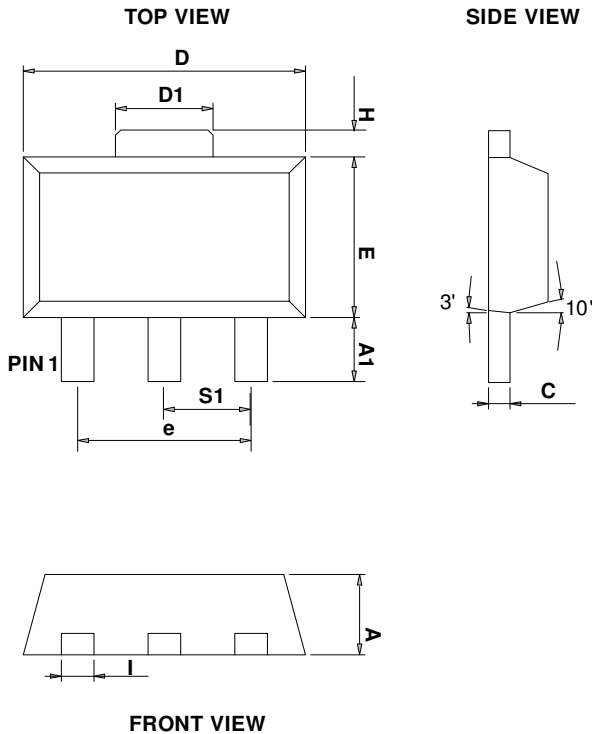


| SYMBOLS | MILLIMETERS | | INCHES | |
|----------------|-------------|------|------------|--------|
| | MIN | MAX | MIN | MAX |
| A | 1.35 | 1.75 | 0.0531 | 0.0689 |
| A ₁ | 0.10 | 0.30 | 0.0039 | 0.0118 |
| A ₂ | 1.473 REF | | 0.0580 REF | |
| B | 0.33 | 0.51 | 0.0130 | 0.0201 |
| C | 0.17 | 0.25 | 0.0067 | 0.0098 |
| D | 4.70 | 5.33 | 0.1850 | 0.2098 |
| E | 3.80 | 4.00 | 0.1496 | 0.1575 |
| e | 1.27 BSC | | 0.0500 BSC | |
| L | 0.40 | 1.27 | 0.0157 | 0.0500 |
| H | 5.80 | 6.30 | 0.2283 | 0.2480 |
| y | - | 0.10 | - | 0.0039 |
| θ | 0° | 8° | 0° | 8° |

AME8855

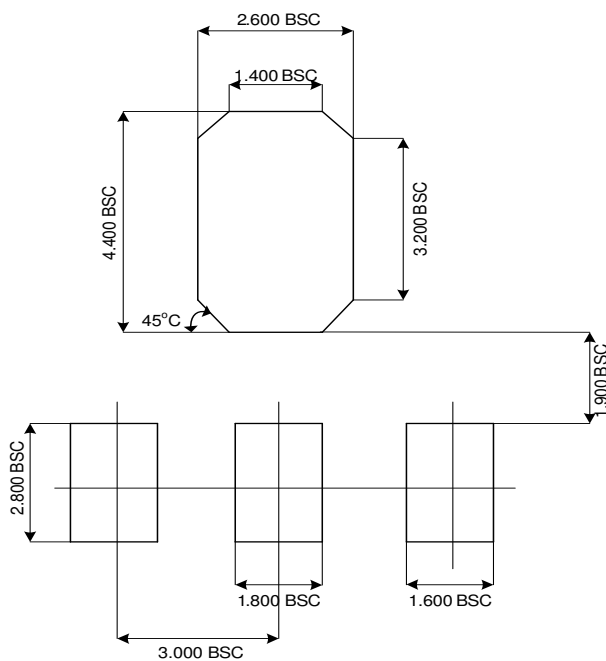
■ Package Dimension (Contd.)

SOT-89



| SYMBOLS | MILLIMETERS | | INCHES | |
|----------------|-------------|------|------------|--------|
| | MIN | MAX | MIN | MAX |
| A | 1.39 | 1.60 | 0.0547 | 0.0630 |
| A ₁ | 0.8 REF | | 0.0315 REF | |
| C | 0.35 | 0.44 | 0.0138 | 0.0173 |
| D | 4.39 | 4.60 | 0.1728 | 0.1811 |
| D ₁ | 1.35 | 1.85 | 0.0531 | 0.0728 |
| E | 2.28 | 2.60 | 0.0898 | 0.1024 |
| I | 0.32 | 0.56 | 0.0126 | 0.0220 |
| e | 3.00 REF | | 0.1181 REF | |
| H | 0.70 REF | | 0.0276 REF | |
| S1 | 1.50 REF | | 0.0591 REF | |

■ Lead Pattern



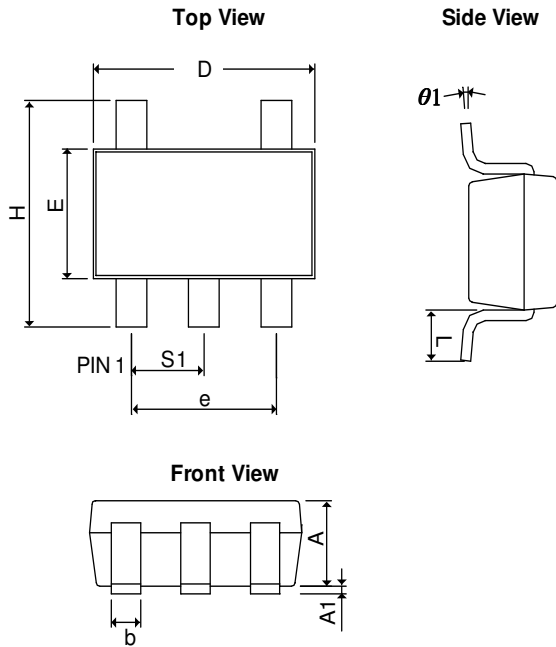
Note:

- Lead pattern unit description:
BSC: Basic. Represents theoretical exact dimension or dimension target.
- Dimensions in Millimeters.
- General tolerance $\pm 0.05\text{mm}$ unless otherwise specified.

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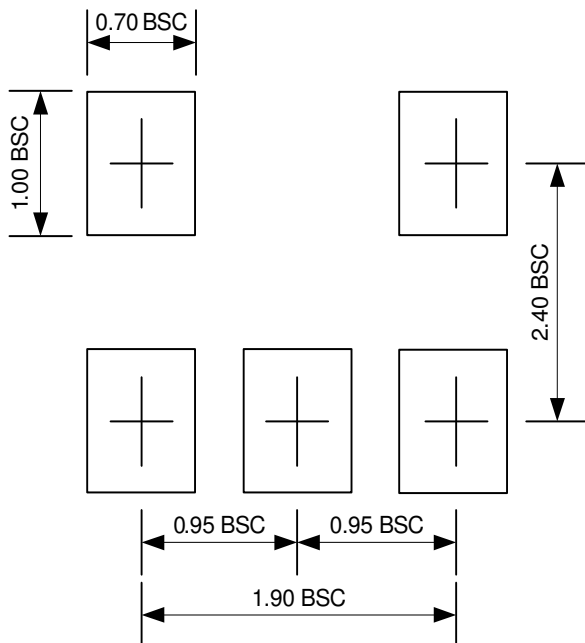
■ Package Dimension (Contd.)

SOT-25



| SYMBOLS | MILLIMETERS | | INCHES | |
|----------------|-------------|------|------------|--------|
| | MIN | MAX | MIN | MAX |
| A | 0.90 | 1.30 | 0.0354 | 0.0512 |
| A ₁ | 0.00 | 0.15 | 0.0000 | 0.0059 |
| b | 0.30 | 0.55 | 0.0118 | 0.0217 |
| D | 2.70 | 3.10 | 0.1063 | 0.1220 |
| E | 1.40 | 1.80 | 0.0551 | 0.0709 |
| e | 1.90 BSC | | 0.0748 BSC | |
| H | 2.60 | 3.00 | 0.1024 | 0.1181 |
| L | 0.37 BSC | | 0.0146 BSC | |
| $\theta 1$ | 0° | 10° | 0° | 10° |
| S ₁ | 0.95 BSC | | 0.0374 BSC | |

■ Lead Pattern



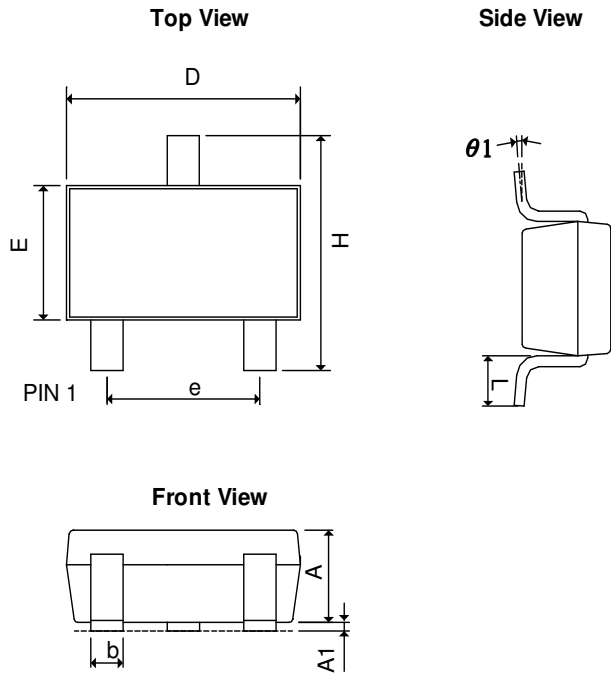
Note:

- Lead pattern unit description:
BSC: Basic. Represents theoretical exact dimension or dimension target.
- Dimensions in Millimeters.
- General tolerance $\pm 0.05\text{mm}$ unless otherwise specified.

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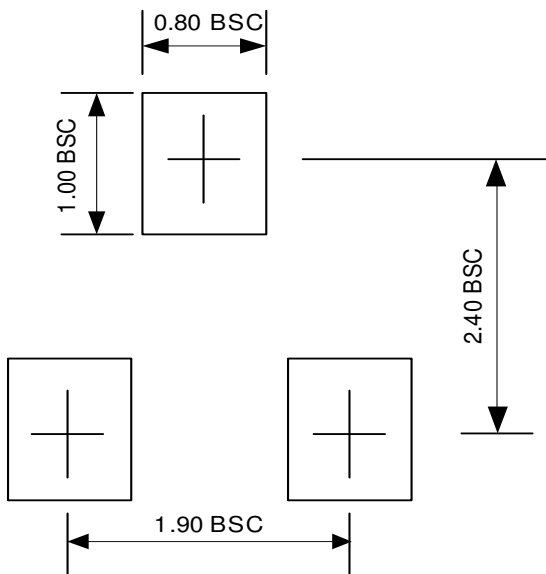
■ Package Dimension (Contd.)

SOT-23



| SYMBOLS | MILLIMETERS | | INCHES | |
|----------------|-------------|------|------------|--------|
| | MIN | MAX | MIN | MAX |
| A | 0.90 | 1.40 | 0.0354 | 0.0551 |
| A ₁ | 0.00 | 0.15 | 0.0000 | 0.0059 |
| b | 0.30 | 0.50 | 0.0118 | 0.0197 |
| D | 2.70 | 3.10 | 0.1063 | 0.1220 |
| E | 1.40 | 1.80 | 0.0551 | 0.0709 |
| e | 1.90 BSC | | 0.0748 BSC | |
| H | 2.40 | 3.00 | 0.0945 | 0.1181 |
| L | 0.35BSC | | 0.0138 BSC | |
| $\theta 1$ | 0° | 10° | 0° | 10° |

■ Lead Pattern



Note:

- Lead pattern unit description:
BSC: Basic. Represents theoretical exact dimension or dimension target.
- Dimensions in Millimeters.
- General tolerance $\pm 0.05\text{mm}$ unless otherwise specified.



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